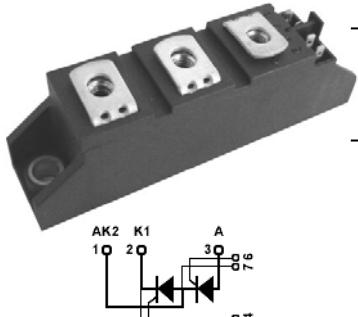


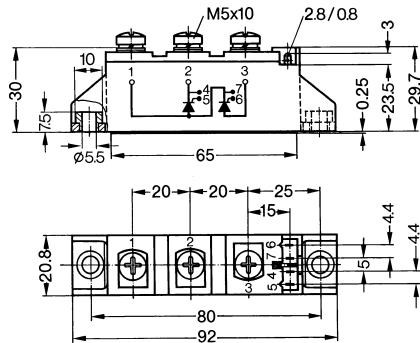
# STT60GKxx

## Thyristor-Thyristor Modules



Type	$V_{RSM}$ V	$V_{RRM}$ V
	$V_{DSM}$	$V_{DRM}$
STT60GK08	900	800
STT60GK12	1300	1200
STT60GK14	1500	1400
STT60GK16	1700	1600
STT60GK18	1900	1800

Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
$I_{TRMS}, I_{FRMS}$	$T_{VJ}=T_{VJM}$	100	
$I_{TAVM}, I_{FAVM}$	$T_c=83^\circ C; 180^\circ$ sine	64	
	$T_c=85^\circ C; 180^\circ$ sine	60	A
$I_{TSM}, I_{FSM}$	$T_{VJ}=45^\circ C$ $V_R=0$ $t=10ms (50Hz), sine$ $t=8.3ms (60Hz), sine$	1500 1600	
	$T_{VJ}=T_{VJM}$ $V_R=0$ $t=10ms(50Hz), sine$ $t=8.3ms(60Hz), sine$	1350 1450	A
$\int i^2 dt$	$T_{VJ}=45^\circ C$ $V_R=0$ $t=10ms (50Hz), sine$ $t=8.3ms (60Hz), sine$	11200 10750	
	$T_{VJ}=T_{VJM}$ $V_R=0$ $t=10ms(50Hz), sine$ $t=8.3ms(60Hz), sine$	9100 8830	$A^2 s$
$(di/dt)_{cr}$	$T_{VJ}=T_{VJM}$ $f=50Hz, t_p=200\mu s$ $V_D=2/3V_{DRM}$ $I_G=0.45A$ $dI_G/dt=0.45A/\mu s$	150 500	$A/\mu s$
$(dv/dt)_{cr}$	$T_{VJ}=T_{VJM};$ $R_{GK}=\infty$ ; method 1 (linear voltage rise)	1000	$V/\mu s$
$P_{GM}$	$T_{VJ}=T_{VJM}$ $I_T=I_{TAVM}$ $t_p=30\mu s$ $t_p=300\mu s$	10 5	W
$P_{GAV}$		0.5	W
$V_{RGM}$		10	V
$T_{VJ}$ $T_{VJM}$ $T_{stg}$		-40...+125 125 -40...+125	$^\circ C$
$V_{ISOL}$	50/60Hz, RMS $I_{ISOL}\leq 1mA$	3000 3600	V~
$M_d$	Mounting torque (M5) Terminal connection torque (M5)	2.5-4.0/22-35 2.5-4.0/22-35	Nm/lb.in.
<b>Weight</b>	Typ.	81	g

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# STT60GKxx

## Thyristor-Thyristor Modules

Symbol	Test Conditions	Characteristic Values	Unit
$I_{RRM}, I_{DRM}$	$T_{VJ}=T_{VJM}; V_R=V_{RRM}; V_D=V_{DRM}$	5	mA
$V_T, V_F$	$I_T, I_F=200A; T_{VJ}=25^\circ C$	1.57	V
$V_{TO}$	For power-loss calculations only ( $T_{VJ}=125^\circ C$ )	0.85	V
$r_T$		3.7	$m\Omega$
$V_{GT}$	$V_D=6V; T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	1.5 1.6	V
$I_{GT}$	$V_D=6V; T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	100 200	mA
$V_{GD}$	$T_{VJ}=T_{VJM}; V_D=2/3V_{DRM}$	0.2	V
$I_{GD}$		10	mA
$I_L$	$T_{VJ}=25^\circ C; t_p=10\mu s; V_D=6V$ $I_G=0.45A; dI/dt=0.45A/\mu s$	450	mA
$I_H$	$T_{VJ}=25^\circ C; V_D=6V; R_{GK}=\infty$	200	mA
$t_{gd}$	$T_{VJ}=25^\circ C; V_D=1/2V_{DRM}$ $I_G=0.45A; dI/dt=0.45A/\mu s$	2	us
$t_q$	$T_{VJ}=T_{VJM}; I_T=150A; t_p=200\mu s; -dI/dt=10A/\mu s$ $V_R=100V; dv/dt=20V/\mu s; V_D=2/3V_{DRM}$	typ. 150	us
$Q_s$	$T_{VJ}=T_{VJM}; I_T, I_F=50A; -dI/dt=3A/\mu s$	100	uC
$I_{RM}$		24	A
$R_{thJC}$	per thyristor/diode; DC current per module	0.45 0.225	K/W
$R_{thJK}$	per thyristor/diode; DC current per module	0.65 0.325	K/W
$d_s$	Creeping distance on surface	12.7	mm
$d_A$	Strike distance through air	9.6	mm
$a$	Maximum allowable acceleration	50	$m/s^2$

### FEATURES

- \* International standard package
- \* DCB base plate
- \* Glass passivated chips
- \* Isolation voltage 3600 V~
- \* UL file NO.310749
- \* RoHs compliant

### APPLICATIONS

- \* DC motor control
- \* Softstart AC motor controller
- \* Light, heat and temperature control

### ADVANTAGES

- \* Space and weight savings
- \* Simple mounting with two screws
- \* Improved temperature and power cycling
- \* Reduced protection circuits

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## Thyristor-Thyristor Modules

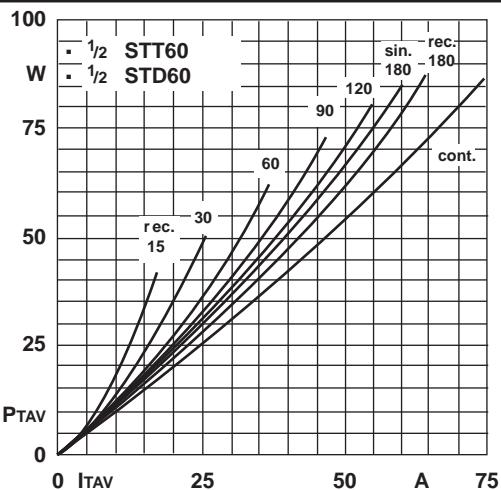


Fig.1L Power dissipation per thyristor vs. on-state current

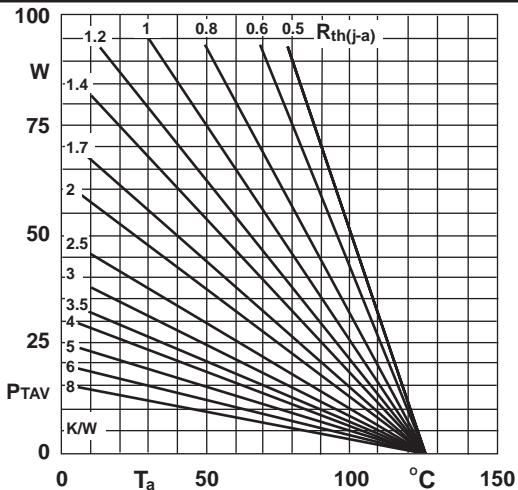


Fig.1R Power dissipation per thyristor vs. ambient temp

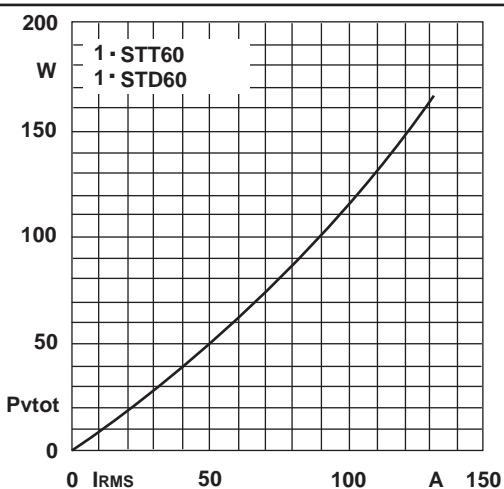


Fig.2L Power dissipation per module vs. rms current

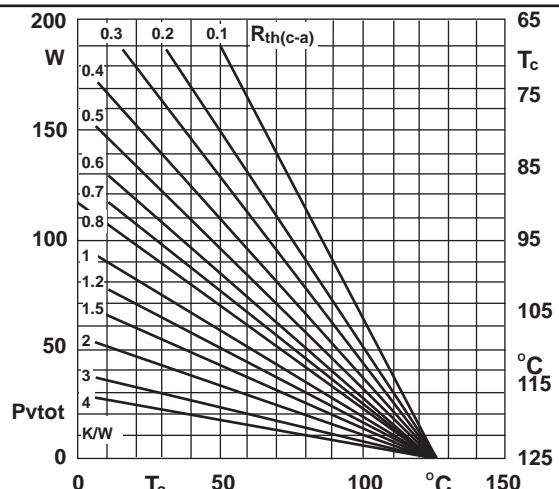


Fig.2R Power dissipation per module vs. case temp

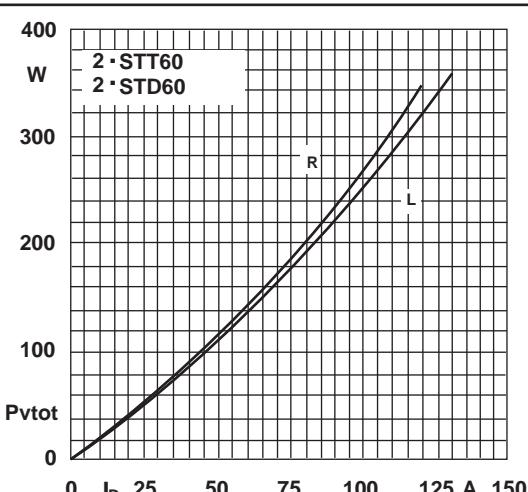


Fig.3L Power dissipation of two modules vs. direct current

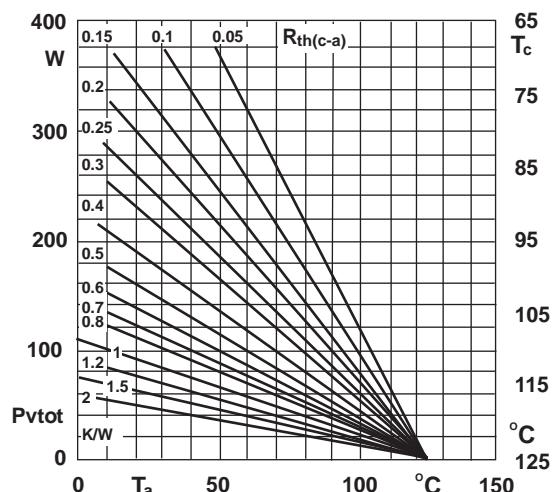


Fig.3R Power dissipation of two modules vs. case temp

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# STT60GKxx

## Thyristor-Thyristor Modules

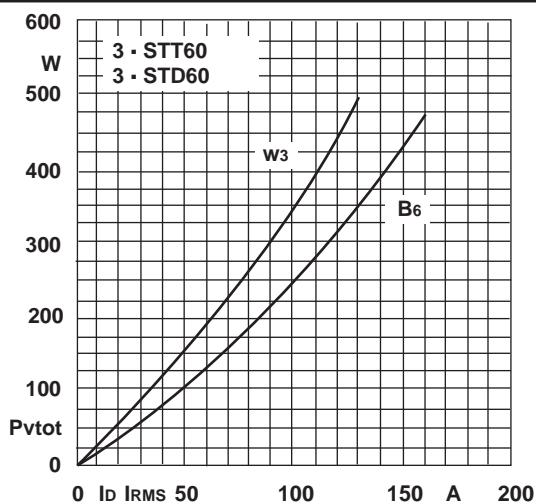


Fig.4L Power dissipation of three modules vs. direct and rms current

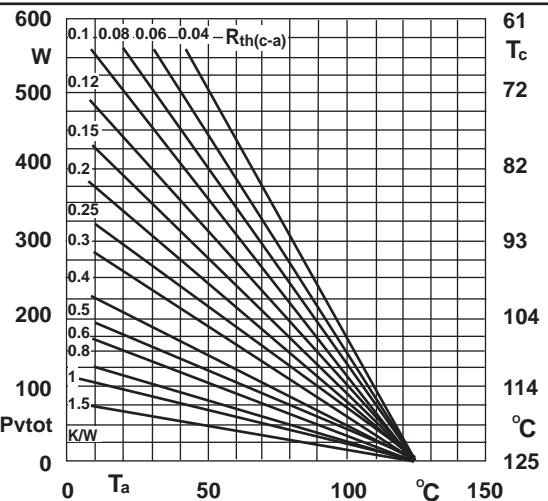


Fig.4R Power dissipation of three modules vs. case temp

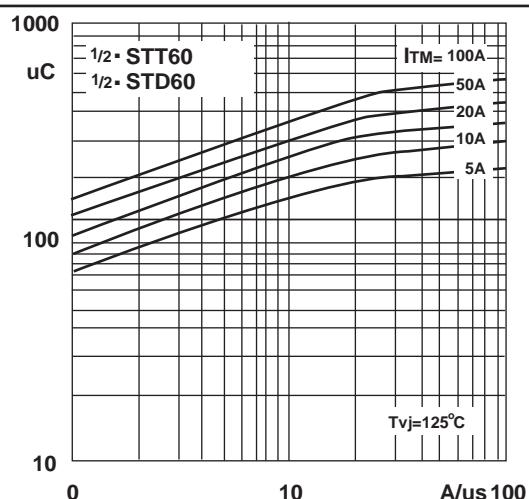


Fig.5 Recovered charge vs. current decrease

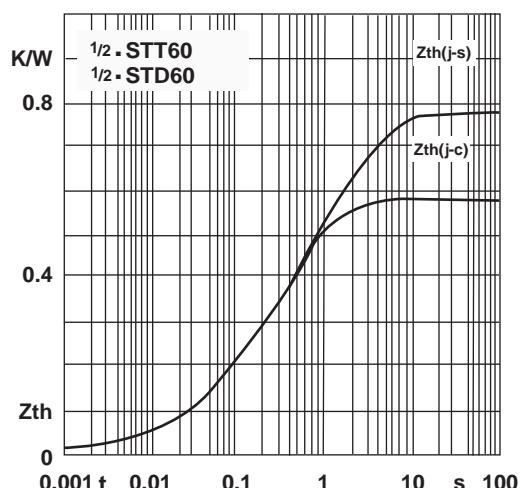


Fig.6 Transient thermal impedance vs. time

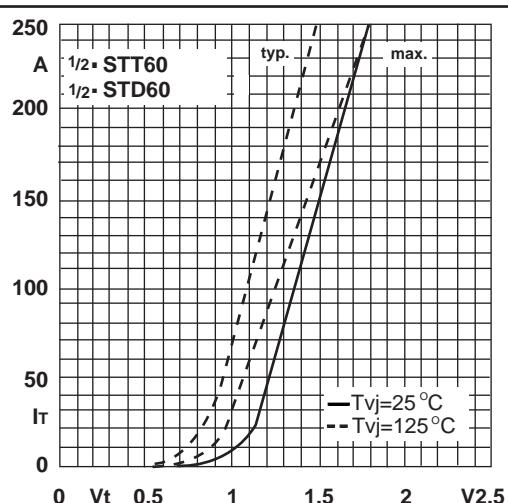


Fig.7 On-state characteristics

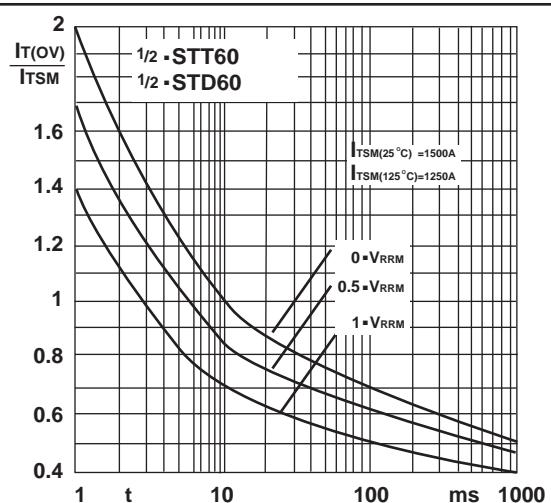


Fig.8 Surge overload current vs. time

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